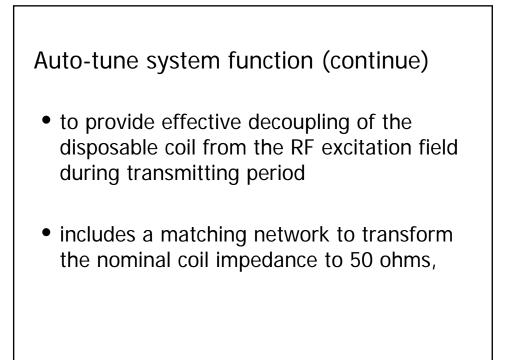
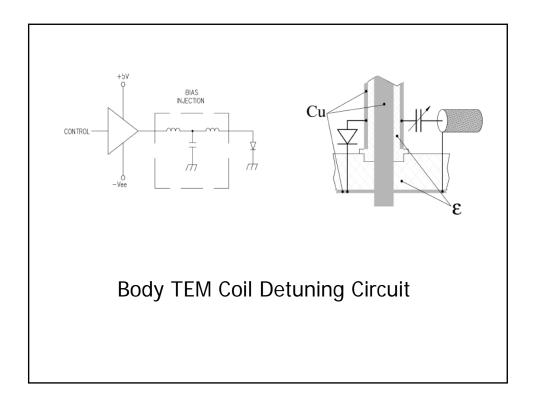
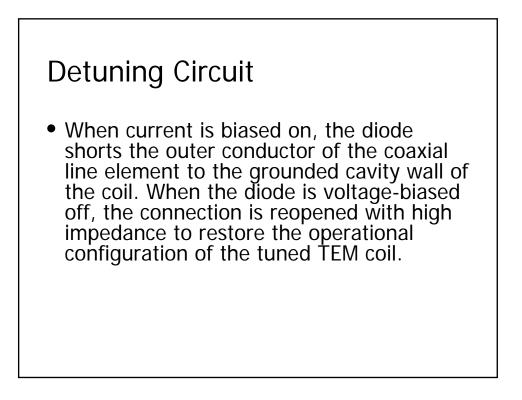


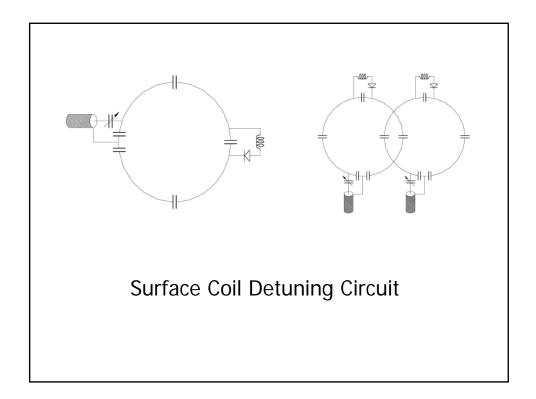


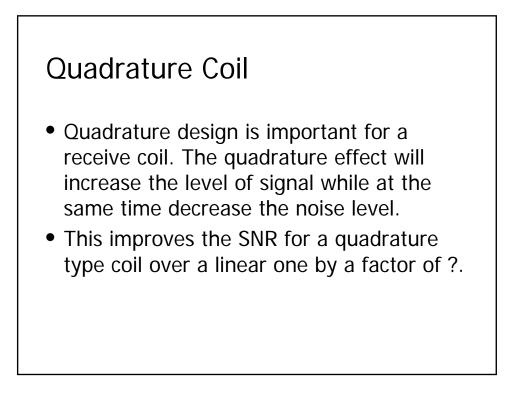
- electronically optimizes the tuning of the disposable coil on a per-coil and perpatient basis by sweeping an electronically controlled reactance through a range of values
- locking in the value which provides the optimum response at the nominal X MHz MRI system frequency.

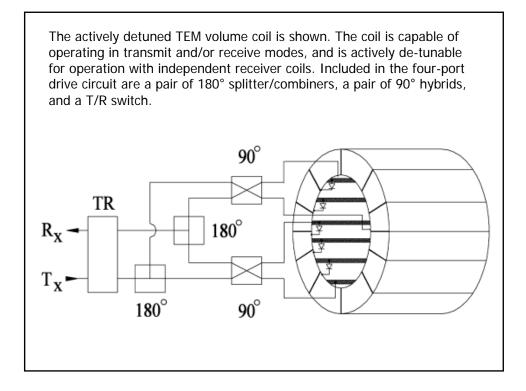


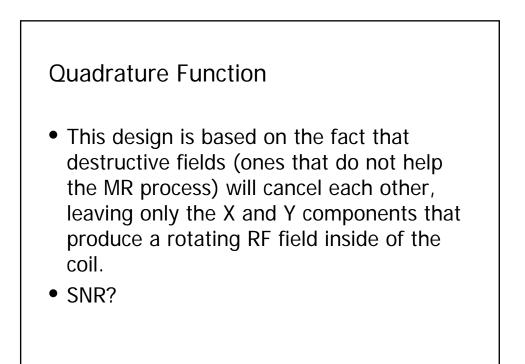


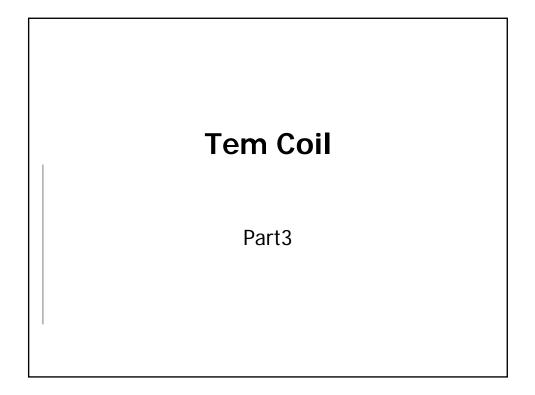


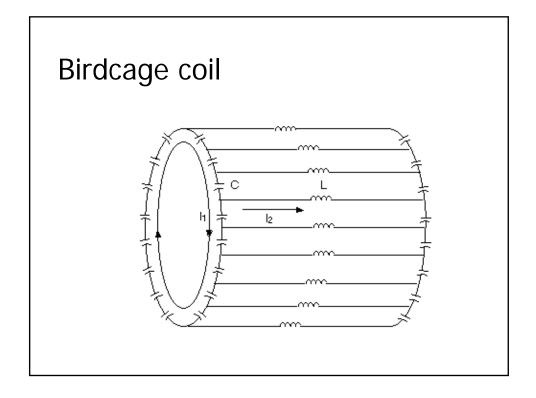


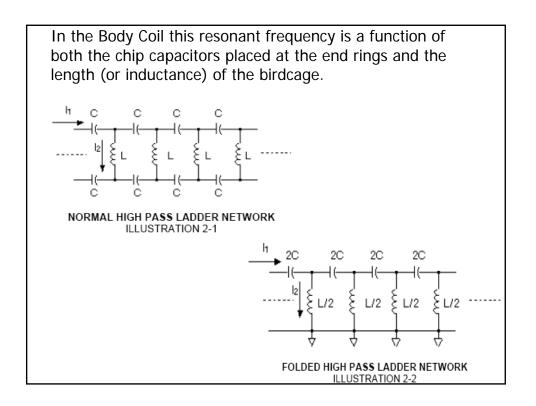


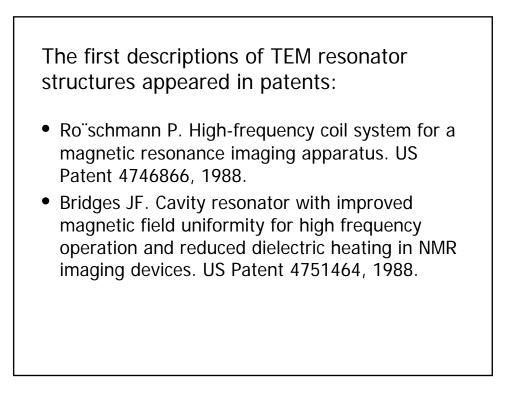










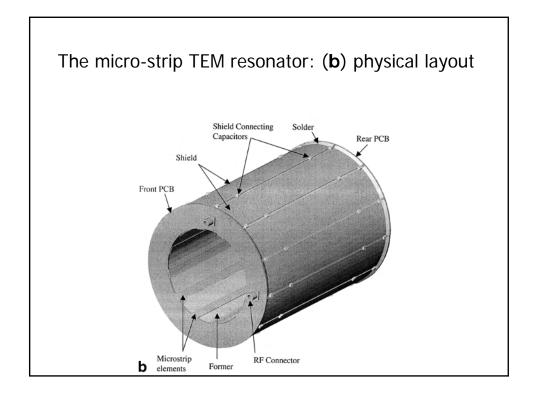


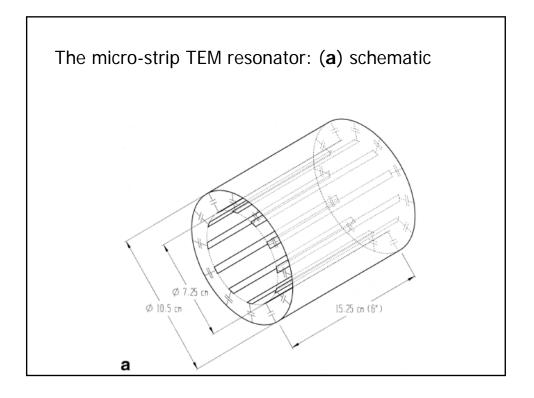
Two definitions help to describe and clarify the integral cavity component of the TEM coil circuit, and to differentiate it from the shield often used with the birdcage coil design.

 A cavity is a metallic
a shield is a metallic covering placed around or between electric circuits to suppress the effects of undesired signals

The definition of TEM Coil

 Further, a cavity resonator is a space which is normally bounded by an electrically conducting surface and in which oscillating electromagnetic energy is stored; the resonant frequency is determined by the geometry of the enclosure. The TEM coil by definition, is a cavity resonator.





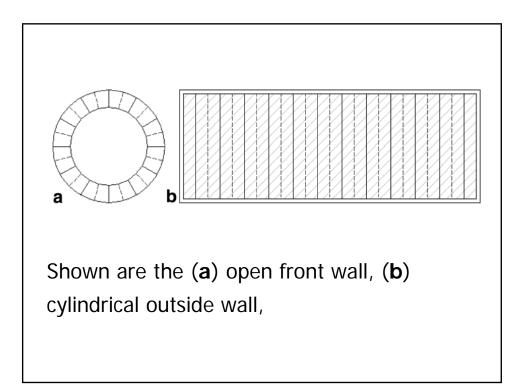
Both the birdcage shield and the TEM cavity must be segmented or slotted to sufficiently break up switched gradientinduced eddy currents.

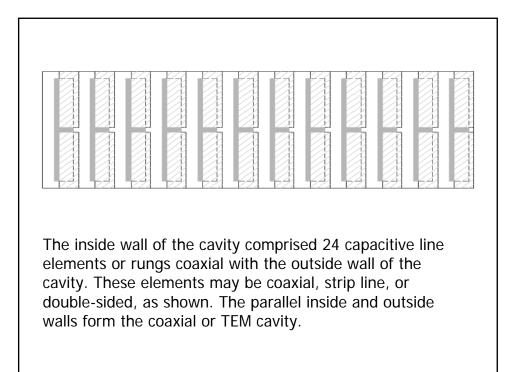
the Birdcage Coil

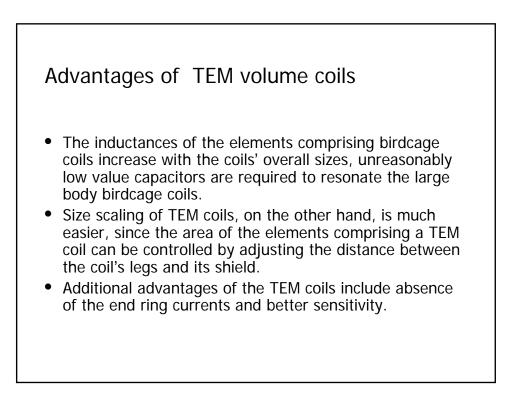
 Viewing the birdcage with its end rings as a closed-ladder network of loops, the optimal birdcage shield is segmented in thumbprint patterns so as to not interrupt looping RF current patterns induced on the shield by the cage currents

TEM resonator

• The significant current return path from the line elements in the TEM resonator is on the cavity wall, in the *z* direction. The TEM cavity must be segmented in the *z* direction, from the front (head entry side), to the back wall of the cavity. Any *x* or *y* component in the TEM cavity segmentation pattern interrupts or adds inductance to the return path circuit. A thumbprint design for the TEM cavity would therefore be suboptimal.







Etched Connection

 Connected slots were etched in the front, back, and cylindrical outside walls of the TEM cavity. The slots were etched on two sides of a doublesided 5-µ-thick copper film deposited on a 12-µthick polyimide substrate. The slots on one side were overlapped by lands on the other side. The capacitive bridging thereby achieved between the segments provides low impedance to the RF currents and high impedance to the gradientinduced eddy currents between segments, improving the RF conduction efficiency and shielding qualities of the cavity.

